

English

Search Microchip

Search Data Sheets

[PRODUCTS](#) [APPLICATIONS](#) [DESIGN SUPPORT](#) [TRAINING](#) [SAMPLE & BUY](#) [ABOUT US](#) [Contact Us](#) [myMicrochip Login](#)

Product Change Notification - JAON-22WRZE808 [\(Printer Friendly\)](#)

Date: 31 Oct 2014

Notification subject: CCB 1476 Initial Notice: Qualification of G700LTD Mold Compound and 8600 Die Attach in various QFN packages using EFTC64T LF at NSEB (UTL).

Notification text: **PCN Status:**
Initial notification

Microchip Parts Affected:

See attachments of affected catalog part numbers (CPN) labeled as...

PCN_JAON-22WRZE808_Affected_CPN.xls

PCN_JAON-22WRZE808_Affected_CPN.pdf

Description of Change:

Qualification of G700LTD Mold Compound and 8600 Die Attach in various QFN packages using EFTC64T LF at NSEB (UTL).

Pre Change:

G770HCD mold compound and 8006NS or 8200T die attach

Post Change:

G700LTD mold compound and 8600 die attach

Impacts to Data Sheet:

None

Reason for Change:

To Improve Manufacturability by qualifying G700LTD mold compound and 8600 die attach at this assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

February 28, 2015 (date code: 1509)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

October 31, 2014: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): [PCN_JAON-22WRZE808_Qual Plan.pdf](#)
[PCN_JAON-22WRZE808_Affected_CPN.pdf](#)
[PCN_JAON-22WRZE808_Affected_CPN.xlsx](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to change your product/process change notification (PCN) profile please log on to our website at <http://www.microchip.com/PCN> sign into myMICROCHIP to open the myMICROCHIP home page, then select a profile option from the left navigation bar.

To opt out of future offer or information emails (other than product change notification emails), click here to go to [microchipDIRECT](#) and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."



[Products](#) [Applications](#) [Design Support](#) [Training](#) [Sample & Buy](#) [About Us](#) [Contact Us](#)
[Legal](#) [Investors](#) [Careers](#)

©Copyright 1998-2014 Microchip Technology Inc. All rights reserved.
Shanghai ICP Recordal No.09049794